

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Satoshi SAKUMA	12/22/2009
Eiko OKAMOTO	12/22/2009
Yoshihiro UOZU	12/22/2009
RECEIVING PARTY DATA	
Name:	Mitsubishi Rayon Co., Ltd.
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Postal Code:	108-8506
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12526195
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ATTORNEY DOCKET NUMBER:	56819-5020
NAME OF SUBMITTER:	MaryJane Boswell

Total Attachments: 2
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PATENT
REEL: 023826 FRAME: 0130

CH \$40.00 12526195

2592-05
OSP-3063
US 2009/12

ATTORNEY DOCKET NO.: 056819-5020
SOLE/JOINT INVENTION
(U.S. Rights Only)

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

TRANSPARENT MOLDED BODY AND ANTIREFLECTIVE MEMBER USING THE SAME

for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on August 6, 2009, (Application No. 12/526,195); and

WHEREAS, Mitsubishi Rayon Co., Ltd., a corporation of Japan, whose post office address is 6-41, Konan 1-chome, Minato-ku, Tokyo 108-8506 Japan (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. 12/526,195, filed August 6, 2009) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

Full Name of Sole or First Assignor Satoshi SAKUMA	Assignor's Signature <i>Satoshi Sakuma</i>	Date December 22, 2009
Address c/o Mitsubishi Rayon Co., Ltd., Corporate Research Laboratories, 20-1, Miyuki-cho, Otake-shi, Hiroshima 739-0693 Japan		Citizenship Japan
Full Name of Second Assignor Eiko OKAMOTO	Assignor's Signature <i>Eiko Okamoto</i>	Date December 22, 2009
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Names of additional inventors attached <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No		

2572-US
 OSP-30635
 US 2009

Full Name of Third Assignor Yoshihiro UOZU	Assignor's Signature <i>Yoshihiro Uozu</i>	Date December 22, 2009
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Full Name of Sixth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Seventh Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Eighth Assignor	Assignor's Signature	Date
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Full Name of Eleventh Assignor	Assignor's Signature	Date
Address		Citizenship
Names of additional inventors attached <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No		